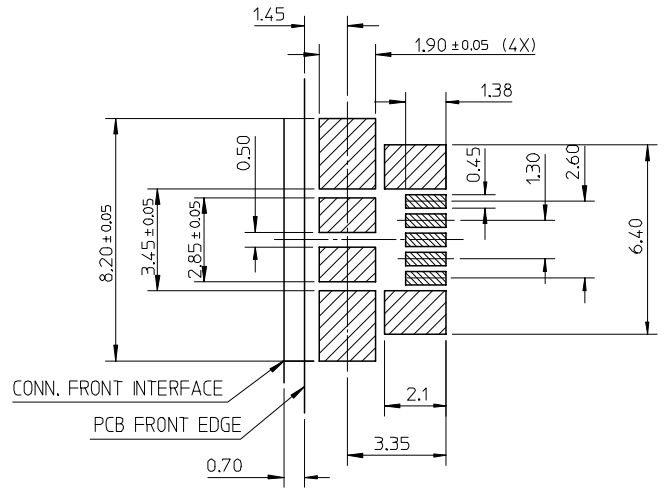


NOTE :

- MATERIAL :  
HOUSING : LCP, BLACK, UL94V-0  
TERMINAL : COPPER ALLOY THICKNESS = 0.15 MM  
SHIELD CASE : STAINLESS STEEL THICKNESS = 0.30 MM
- PLATING :  
TERMINAL:  
CONTACT AREA : GOLD FLASH OVER MINIMUM 0.75 MICRON Pd/Ni.  
SOLDER TAIL AREA : GOLD FLASH.  
UNDER PLATING : NICKEL 2.0 MICRON MINIMUM.
- SHIELD :  
MATTE TIN 3.8 MICRON MINIMUM.  
UNDER PLATING : NICKEL 1.27 MICRON MINIMUM.
- TAIL & NAIL COPLANARITY 0.08 mm MAXIMUM.
- COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC.



RECOMMENDED P.C.B. PATTERN LAYOUT

NEW RELEASE EC NO: SH2007-0765 DRWN:XJSONG 2007/04/24 CHKD:JTIAN 2007/04/24 APPR: JNCHEN 2007/04/27	DESCRIPTION	QUALITY SYMBOLS  ▽=0 ▽C=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 8:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY XJSONG	DATE 2006/12/11	TITLE MICRO USB B REC. BOTTOM MOUNT ASS'Y				
			4 PLACES	± ---	± ---	CHECKED BY	DATE					
			3 PLACES	± ---	± ---	IWANG	2006/12/11					
			2 PLACES	± 0.25	± ---	APPROVED BY	DATE	MOLEX INCORPORATED				
			1 PLACE	± 0.25	± ---	JNCHEN	2006/12/11					
			ANGULAR ± 3 °			MATERIAL NO. 47346-0001		DOCUMENT NO. SD-47346-001		SHEET NO. 1 OF 1		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								